PRODUCT / PROCESS CHANGE NOTIFICATION

1. PCN basic data		
1.1 Company		STMicroelectronics International N.V
1.2 PCN No.		MDG/24/14486
1.3 Title of PCN		STM32U575x & STM32U585x - product Enhancement
1.4 Product Category		STM32U575x STM32U585x
1.5 Issue date		2024-07-10

2. PCN Team		
2.1 Contact supplier		
2.1.1 Name	PIKE EMMA	
2.1.2 Phone	+44 1628896111	
2.1.3 Email	emma.pike@st.com	
2.2 Change responsibility		
2.2.1 Product Manager	Ricardo Antonio DE SA EARP	
2.1.2 Marketing Manager	Veronique BARLATIER	
2.1.3 Quality Manager	Pascal NARCHE	

3. Change			
3.1 Category	3.2 Type of change	3.3 Manufacturing Location	
General Product & Design	Die redesign: Mask or mask set change with new die design like metallization (specifically chip frontside) or bug fix	TSMC FAB14 (Taiwan)	

4. Description of change			
	Old	New	
	STM32U575xx and STM32U585xx - (Die482 - cut3.1 revision W) product shows several limitations as described in Errata Sheet (ES0499 - Rev 9 - January 2024): - Device hang-up can occur when wakeup request received a few clock cycles before entering Stop 2 or Stop 3 mode - Device may be locked upon system reset under Stop 2 mode - Device may hang up when entering low-power modes	STM32U575xx and STM32U585xx - (Die482 - cut3.3 revision U) product enhancement fixes three limitations related to low-power modes as described in Errata Sheet (ES0499 - Rev 10 - July 2024): - Device hang-up can occur when wakeup request received a few clock cycles before entering Stop 2 or Stop 3 mode - Device may be locked upon system reset under Stop 2 mode - Device may hang up when entering low-power modes	
4.2 Anticipated Impact on form,fit, function, quality, reliability or processability?	Functionality enhancement		

5. Reason / motivation for change		
5.1 Motivation Improvements was implemented to increase robustness, performances and quality of oppositions.		
5.2 Customer Benefit	SERVICE IMPROVEMENT	

6. Marking of parts / traceability of change		
6.1 Description traceability ensured by ST internal tools Die revision changes from "W" to "U" on Package Marking.		

7. Timing / schedule		
7.1 Date of qualification results	2024-07-31	
7.2 Intended start of delivery	2024-10-01	
7.3 Qualification sample available?	Upon Request	

8. Qualification / Validation			
8.1 Description	14486 RERMCD1919 STM32U5 Die 482U cut3.3 - qual plan.pdf		
8.2 Qualification report and qualification results	Available (see attachment)	Issue Date	2024-07-10

9. Attachments (additional documentations)

14486 Public product.pdf 14486 RERMCD1919 STM32U5 Die 482U cut3.3 - qual plan.pdf 14486 PCN14486_Additional information.pdf

10. Affected parts			
10. 1 Current	10.2 New (if applicable)		
10.1.2 Supplier Part No	10.1.2 Supplier Part No		
STM32U575AGI6			
STM32U575AGI6Q			
STM32U575AII6			
STM32U575AII6Q			
STM32U575CGU3			
STM32U575CIT6			
STM32U575CIU6Q			
STM32U575OIY6QTR			
STM32U575QII6			
STM32U575QII6Q			
STM32U575RIT6			
STM32U575VIT6			
STM32U575VIT6Q			
STM32U575ZIT6			
STM32U575ZIT6Q			
STM32U585AII6			
STM32U585AII6Q			
STM32U585CIU6			
STM32U585QII6			
STM32U585QII6Q			
STM32U585VIT6			
STM32U585VIT6Q			
STM32U585ZIT6			
STM32U585ZIT6Q			
STM32U585RIT3			
	10.1 Current 10.1.2 Supplier Part No STM32U575AGI6 STM32U575AII6 STM32U575AII6 STM32U575CGU3 STM32U575CIT6 STM32U575CIU6Q STM32U575CIU6Q STM32U575QII6 STM32U575QII6 STM32U575VIT6 STM32U575VIT6 STM32U575ZIT6 STM32U575ZIT6 STM32U575ZIT6 STM32U575ZIT6 STM32U585AII6 STM32U585AII6 STM32U585QII6 STM32U585QII6Q STM32U585QII6Q STM32U585VIT6 STM32U585VIT6 STM32U585VIT6 STM32U585VIT6 STM32U585VIT6 STM32U585ZIT6		

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